ALUMINUM ELECTROLYTIC CAPACITORS

nichicon

WS

Chip Type, High CV
High Temperature (260°C) Reflow
series

For SMD | Anti-Solvent Feature

- Corresponding with 260°C peak reflow soldering
  Recomended reflow condition : 260°C peak 5 sec. 230°C over 60 sec. 2 times
  (φ8×6.2, φ10×10 : 1 time)
- Chip type higher capacitance in large case size.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).

WS
High Temperature Reflow
UR

■Specifications

Item	Performance Characteristics
Category Temperature Range	−40 to +85°C
Rated Voltage Range	6.3 to 50V
Rated Capacitance Range	22 to 1500μF
Capacitance Tolerance	±20% at 120Hz, 20°C
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.03CV (μA) .
tan δ	Measurement frequency : 120Hz, Temperature : 20°C

Rated voltage (V)	6.3	10	16	25	35	50
tan δ (MAX.)	0.28	0.24	0.20	0.16	0.14	0.12

Stability at Low Temperature — Measurement frequency: 120Hz

Rated voltage (V)		6.3	10	16	25	35	50
Impedance ratio ZT / Z20 (MAX.)	Z−25°C / Z+20°C	5	4	3	2	2	2
	Z−40°C / Z+20°C	10	8	6	4	3	3

Endurance — After 2000 hours' application of rated voltage at 85°C, capacitors meet the characteristic requirements listed at right.

Capacitance change	Within ±20% of initial value
tan δ	200% or less of initial specified value
Leakage current	Initial specified value or less

Shelf Life — After storing the capacitors under no load at 85°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.

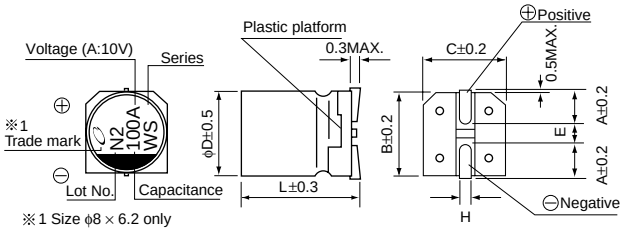
Resistance to soldering heat — The capacitors shall be kept on the hot plate maintained at 250°C, for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.

Capacitance change	Within ±10% of initial value
tan δ	Initial specified value or less
Leakage current	Initial specified value or less

Marking — Black print on the case top.

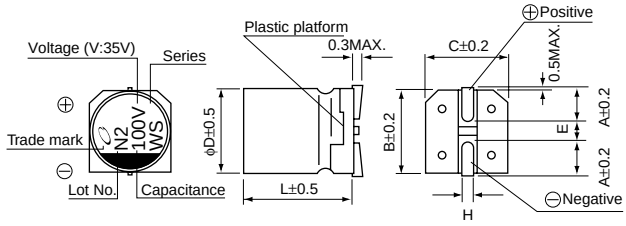
■Chip Type

(φ6.3, φ8 × 6.2)



※1 Size φ8 × 6.2 only

(φ8 × 10, φ10 × 10)



Voltage

V	6.3	10	16	25	35	50
Code	j	A	C	E	V	H

● Dimension table in next page.

Type numbering system (Example : 10V 100μF)

1	2	3	4	5	6	7	8	9	10	11	12	13	14
U	W	S	1	A	1	0	1	M	C	L	1	G	S

- Package code
- Configuration
- Capacitance tolerance (±20%)
- Rated Capacitance (100μF)
- Rated voltage (10V)
- Series name
- Type

(mm)

φD×L	6.3×5.8	6.3×7.7	8×6.2	8×10	10×10
A	2.4	2.4	3.3	2.9	3.2
B	6.6	6.6	8.3	8.3	10.3
C	6.6	6.6	8.3	8.3	10.3
E	2.2	2.2	2.3	3.1	4.5
L	5.8	7.7	6.2	10	10
H	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

WS series

■Dimensions

Cap. (μF) \ V	Code	6.3		10		16		25		35		50	
		0J		1A		1C		1E		1V		1H	
22	220											6.3×5.8	45
33	330									6.3×5.8	55	8×6.2	95
47	470							6.3×5.8	65	8×6.2	105	8×10	140
100	101			6.3×5.8	70	8×6.2	125	8×6.2	145	8×10	175	10×10	195
150	151			6.3×5.8	85	6.3×7.7	151	8×10	192	8×10	214	10×10	238
220	221	8×6.2	160	8×6.2	175	8×10	215	10×10	250	10×10	265	10×10	289
330	331	8×6.2	190	8×10	240	8×10	270	10×10	305	10×10	324		
470	471	8×10	265	8×10	290	10×10	330	10×10	393				
680	681	8×10	318	10×10	374	10×10	396						
1000	102	10×10	400	10×10	454							Case size φD×L (mm)	Rated ripple
1500	152	10×10	489										

Rated Ripple (mArms) at 85°C 120Hz

●Frequency coefficient of rated ripple current

Cap.(μF) \ Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Less than 47	0.80	1.00	1.15	1.40	1.67
100 to 1500	0.85	1.00	1.08	1.20	1.30

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.